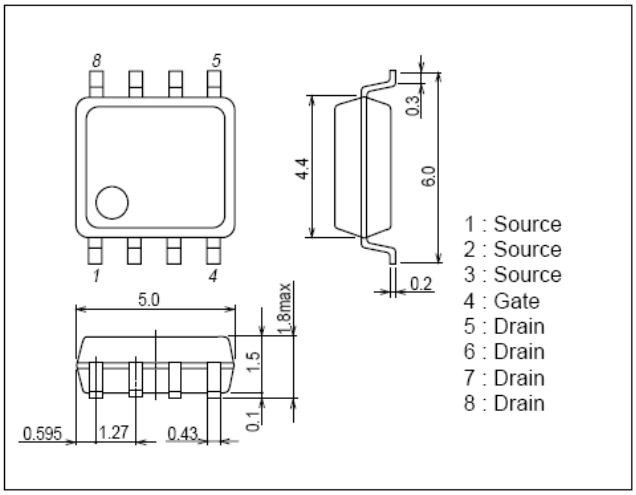
Si4435

Features

- Low On resistance.
- −4.5V drive.
- RoHS compliant.

Package Dimensions

unit : mm
SOP-8



Specifications

Absolute Maximum Ratings at T_a=25^{0}C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V_{DSS}		-30	V
Gate-to-Source Voltage	V_{GSS}		±20	V
Drain Current (DC)	I_D		-8	A
Drain Current (Pulse)	I_{DP}	PW≤10uS, duty cycle≤1%	-50	A
Allowable Power Dissipation	P_D	Mounted on a ceramic board (1000mm^2×0.8mm) 1unit	1.3	W
Total Dissipation	P_T	Mounted on a ceramic board (1000mm^2×0.8mm)	1.7	W
Channel Temperature	T_{ch}		150	^{0}C
Storage Temperature	T_{stg}		-55~+150	^{0}C

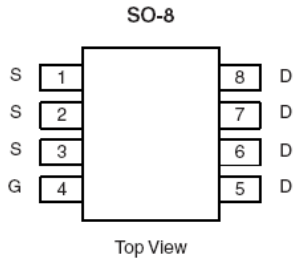
Electrical Characteristics at T_a=25^{0}C

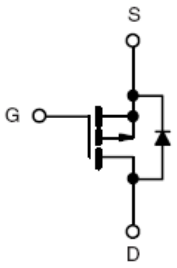
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	I_D=-250uA, V_{GS}=0V	-30			V
Zero-Gate Voltage Drain Current	I_{DSS}	V_{DS}=-30V, V_{GS}=0V			-10	uA
Gate-to-Source Leakage Current	I_{GSS}	V_{GS}=±20V, V_{DS}=0V			±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}= V_{GS}, I_D=-250uA	-1.0	-1.5	-3.0	V
Forward Transconductance	g_{FS}	V_{DS}=-5V, I_D=-10A		24		S
Static Drain-to-Source On-State Resistance	$R_{DS(ON)}$	I_D=-8A, V_{GS}=-10V		15	20	mΩ
	$R_{DS(ON)}$	I_D=-7A, V_{GS}=-4.5V		20	35	mΩ
Input Capacitance	C_{iss}	V_{DS}=-15V, V_{GS}=0V, f=1MHz				pF
Output Capacitance	C_{oss}	V_{DS}=-15V, V_{GS}=0V, f=1MHz				pF
Reverse Transfer Capacitance	C_{rss}	V_{DS}=-15V, V_{GS}=0V, f=1MHz				pF

Electrical Characteristics at T_a=25^{0}C (Continued)

Parameter	Symbol	Conditions	Ratings			Unit
			min	Typ	max	
Turn-on Delay Time	$t_{d(on)}$	V_{GS}=-10V, V_{DS}=-15V, R_L=15Ω, R_{GEN}=6Ω		10	15	nS
Rise Time	t_r			12	25	nS
Turn-off Delay Time	$t_{d(off)}$			110	170	nS
Fall Time	t_f			70	110	nS
Total Gate Charge	Q_g	V_{DS}=-15V, V_{GS}=-10V, I_D=-7A		33	70	nC
Gate-to-Source Charge	Q_{gs}			5.8		nC
Gate-to-Drain “Miller” Charge	Q_{gd}			8.6		nC
Diode Forward Voltage	V_{SD}	I_S=-2.1A, V_{GS}=0V		-0.8	-1.2	V

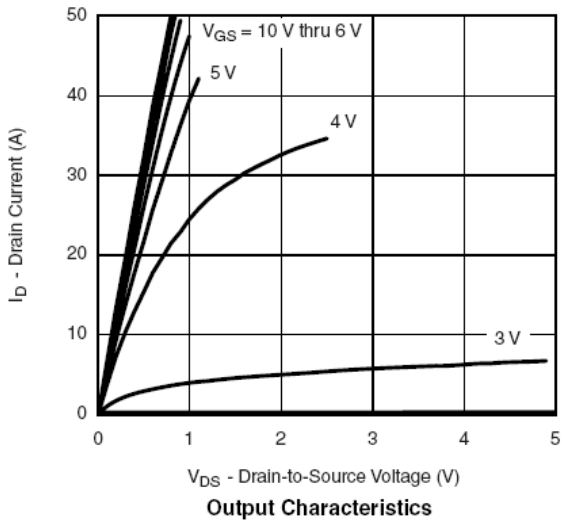
Pin Desctiption



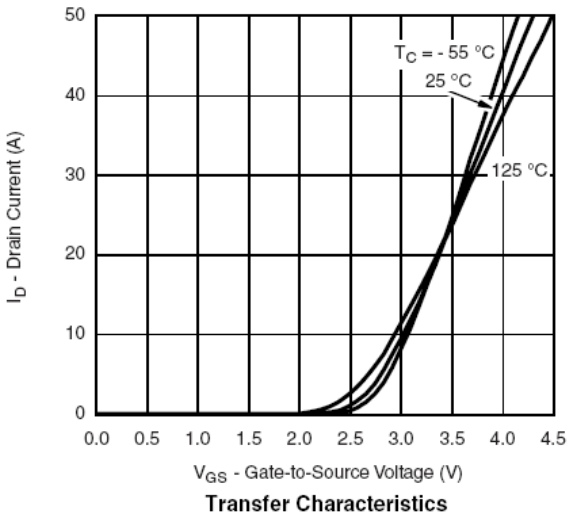


P-Channel MOSFET

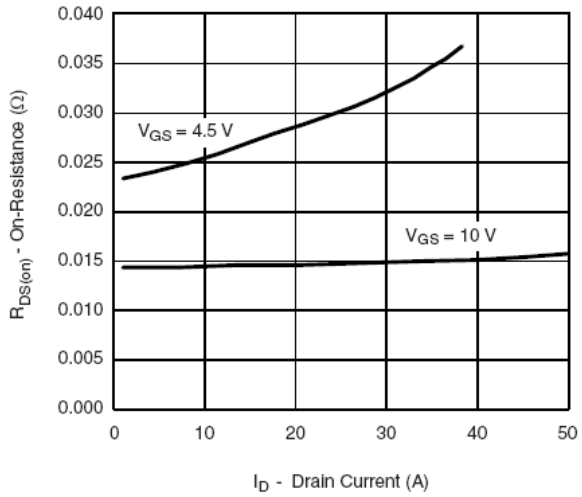
Typical Characteristics at T_a=25^{0}C



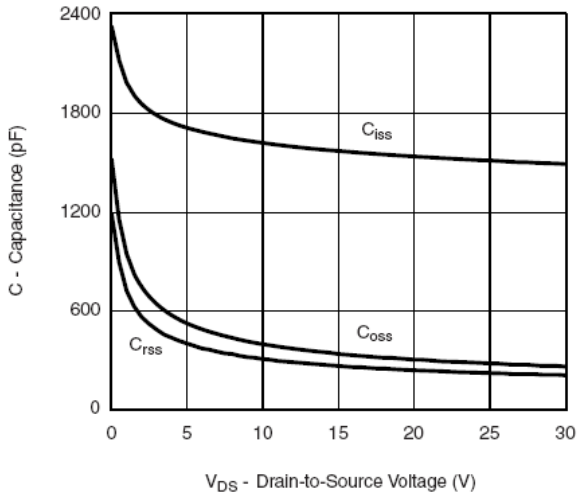
Output Characteristics



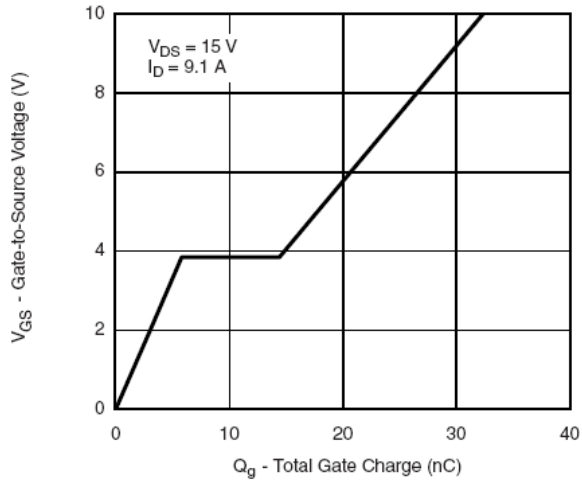
Transfer Characteristics



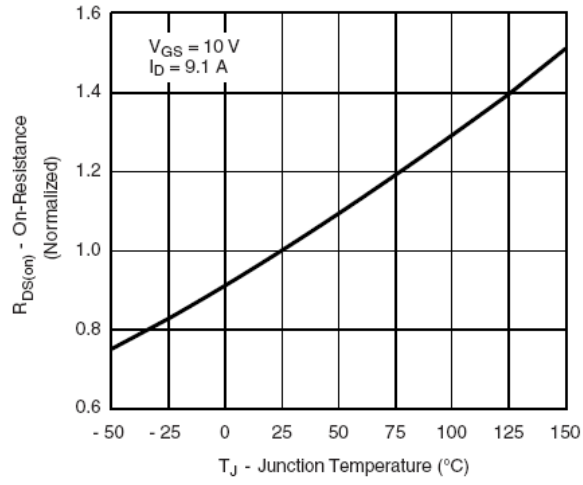
On-Resistance vs. Drain Current



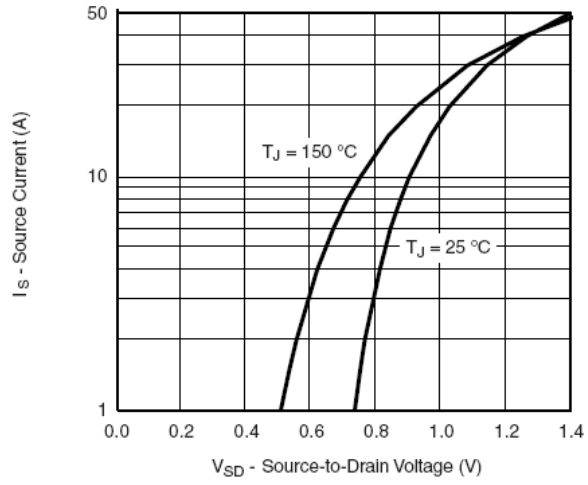
Capacitance



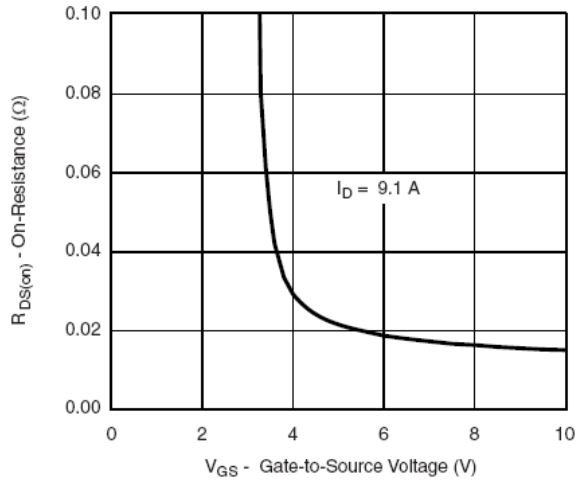
Gate Charge



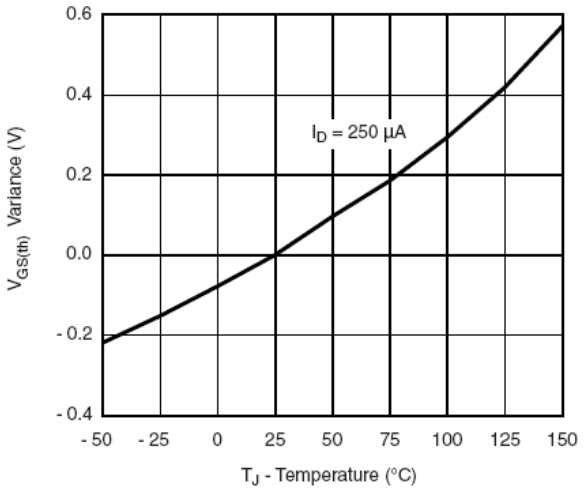
On-Resistance vs. Junction Temperature



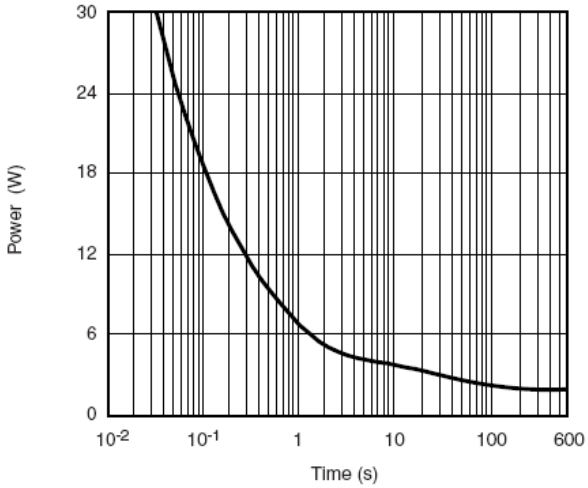
Source-Drain Diode Forward Voltage



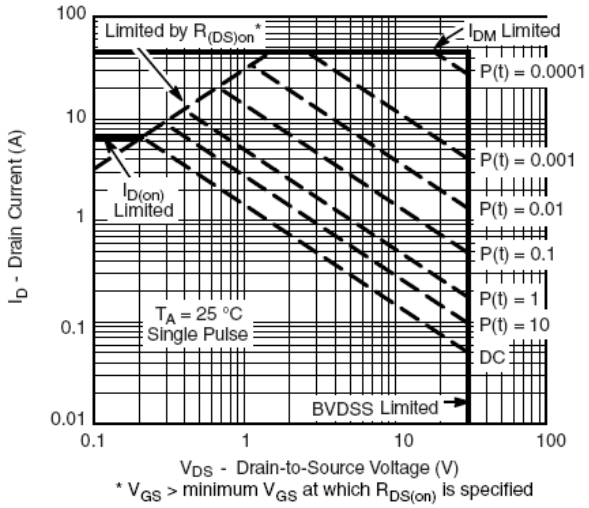
On-Resistance vs. Gate-to-Source Voltage



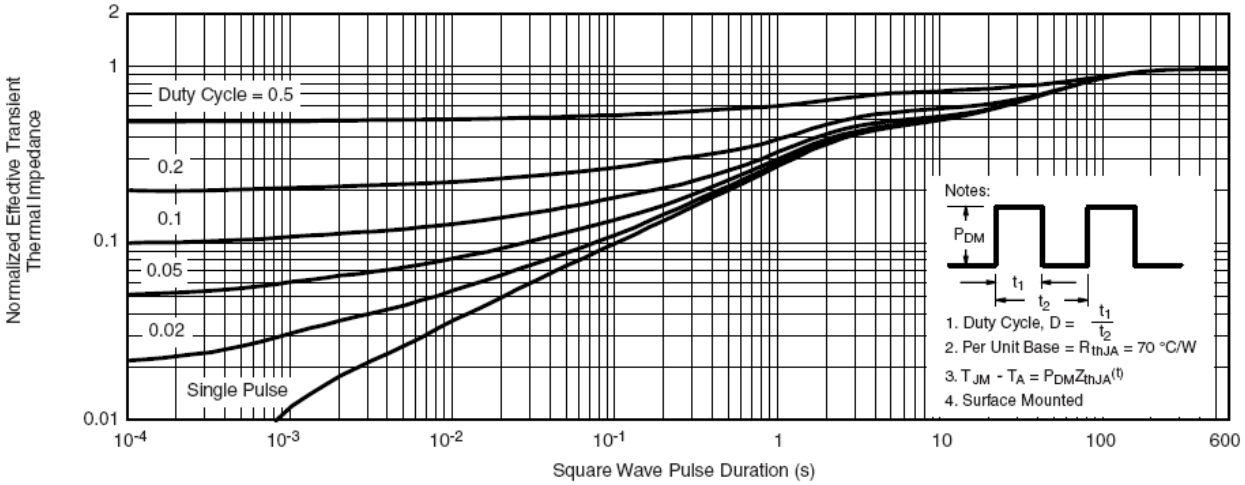
Threshold Voltage



Single Pulse Power



Safe Operating Area, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient